BB02-CE: 1.27mm (0.05") SOCKET, SINGLE ROW, STRAIGHT, THROUGH HOLE, 2 - 35 CONTACTS. PROFILE: 8.5MM

SPECIFICATIONS:
- CURRENT RATING: 1 AMP
- INSULATOR RESISTANCE: 1000 MEGOHMS MIN.
- CONTACT RESISTANCE: 20m ohms MAX.
- DIELECTRIC WITHSTANDING: AC 300 V
- OPERATING TEMPERATURE: -40°C TO +105°C
- CONTACT MATERIAL: PHOSPHOR BRONZE
- INSULATOR MATERIAL: THERMOPLASTIC, UL 94V-0
- PLATING: GOLD, TIN OR SELECTIVE OVER 30-50U" NICKEL
- SOLDERABILITY: IR REFLOW: 280°C FOR 10 SEC
  WAVE: 250°C FOR 5-10 SEC
  MANUAL SOLDER: 380°C FOR 3-5 SEC

PACKED IN TUBE OR BOX.

NOTES:
1. RECOMMENDED MATING PIN LENGTH: 0.40MM

MATES WITH:
- (0.46MM SQUARE PINS)
  - BB02-BL
  - BB02-NH
  - BB02-8M
  - BB02-NM

HOW TO ORDER:

BB02 - CEXXX2 - X03 - 3000000

CONTACT PLATING OPTIONS
- K = GOLD FLASH (STANDARD)
- A = 10U" GOLD ON CONTACT/GOLD FLASH ON TAIL
- B = 15U" GOLD ON CONTACT/GOLD FLASH ON TAIL
- C = 30U" GOLD ON CONTACT/GOLD FLASH ON TAIL
- T = BRIGHT TIN
- M = MATT TIN
- D = GOLD FLASH ON CONTACT/BRIGHT TIN ON TAIL

RECOMMENDED PCB BOARD HOLE LAYOUT
(TOLERANCE: ±0.05)